

The Metropolis of Tokyo (Tokyo Social Bonds (5 year Bond)) series 1 Terms and Conditions

1. Issuer The Metropolis of Tokyo
2. Issue Amount JPY30bln
3. Denominations JPY10,000,000
Pursuant to the Law concerning Book-Entry Transfer of Corporate Bonds, Stocks, etc. (Law No.75 of 2001)
4. Coupon 0.005%
5. Issue Price 100.00%
6. Redemption 100.00%
7. Method and Date of Maturity Payment
 - ① The bond will be redeemed at their principal amount on 19 June, 2026
 - ② If the maturity date falls on a bank's non business day, the payment will be advanced to the preceding business day.
 - ③ The metropolis may at any time purchase or otherwise acquire the Bonds.
8. Method and Date of Interest Payment
 - ① Interest shall accrue on this bond semi-annually from and including the next following date after the issue date to and including the maturity date and shall be payable by semi-annual installments in arrear on 25th day of February and August each year (the first payment is due on 25 February, 2022).
 - ② When it is necessary to compute an amount of interest in respect of a Bond for a period of less than a half year for the period from the following day of the issue date to 25 August, 2021 or for the period leading to the redemption, such interest shall be calculated on the basis of the actual number of days.
 - ③ If any interest payment date falls on a bank's non business day, the payment will be advanced to the preceding business day.
 - ④ No interest is to be accrued after the maturity date.
9. Offering 25 June, 2021
10. Allocation Method If there is oversubscription, allocation will be done by the Lead Managers at their direction.
11. Closing 6 July, 2021
12. Ratings A+ (S&P Global Ratings Japan Inc.)

13. Commissioned bank Mizuho Bank, Ltd.
14. Underwriters Mitsubishi UFJ Morgan Stanley Securities Co., Ltd.
(Lead Manager, Handling Manager)
Mizuho Securities Co., Ltd. (Lead Manager)
Goldman Sachs Japan Co., Ltd.(Lead Manager)
Daiwa Securities Co. Ltd. (Lead Manager)
15. Book-Entry Transfer Institution
Japan Securities Depository Center, Inc.